

# SPECIFICATION

DEVICE NAME : Power MOSFET

TYPE NAME : 2SK2520-01MR

SPEC. No. :

Fuji Electric Co.,Ltd.

This Specification is subject to change without notice.

	DATE	NAME	APPROVED	Fuji Electric Co.,Ltd.		
DRAWN				DWG.NO.	1/11	
CHECKED						

1. Scope  
This specifies Fuji power MOSFET 2SK2520-01MR
2. Construction N-channel enhancement mode power MOSFET
3. Application for switching
4. Outview TO-220F Outviwe See to 5/11 page
5. Absolute maximum ratings at Tc=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-source voltage	$V_{DS}$	200	V	
Drain-gate voltage	$V_{DGR}$	200	V	$R_{GS} = 20\text{K}\Omega$
Continuous Drain current	$I_D$	$\pm 10$	A	
Pulsed drain current	$I_{DPULSE}$	$\pm 40$	A	
Gate-source voltage	$V_{GS}$	$\pm 30$	V	
Maximum power dissipation	$P_D$	30	W	
Operating and storage temperature range	$T_{CH}$	150	°C	
	$T_{STG}$	-55 ~ +150	°C	

6. Electrical characteristics at Tc=25°C (unless otherwise specified)
- Static ratings

Description	Symbol	Conditions	Characteristics			Unit	
			Min.	Typ.	Max.		
Drain-source breakdown voltage	$BV_{DSS}$	$I_D = 1\text{mA}$ $V_{GS} = 0\text{V}$	200			V	
Gate threshold voltage	$V_{GS(th)}$	$I_D = 1\text{mA}$ $V_{DS} = V_{GS}$	2.5	3.0	3.5	V	
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 200\text{V}$ $V_{GS} = 0\text{V}$	$T_{CH} = 25^\circ\text{C}$		10	500	$\mu\text{A}$
	$I_{DSS}$		$T_{CH} = 125^\circ\text{C}$		0.2	1.0	mA
Gate-source leakage current	$I_{GSS}$	$V_{GS} = \pm 30\text{V}$ $V_{DS} = 0\text{V}$		10	100	nA	
Drain-source on-state resistance	$R_{DS(on)}$	$I_D = 5\text{A}$ $V_{GS} = 10\text{V}$		0.35	0.4	$\Omega$	

Dynamic ratings

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Forward transconductance	$g_{fs}$	$I_o = 5\text{ A}$ $V_{os} = 25\text{ V}$	2.0	4.5		S
Input capacitance	$C_{iss}$	$V_{os} = 25\text{ V}$ $V_{gs} = 0\text{ V}$ $f = 1\text{ MHz}$		500	750	pF
Output capacitance	$C_{oss}$			110	170	pF
Reverse transfer capacitance	$C_{rss}$			50	80	pF
Turn-on time	$t_{d(on)}$	$V_{cc} = 150\text{ V}$ $V_{gs} = 10\text{ V}$ $I_o = 10\text{ A}$ $R_{gs} = 10\ \Omega$		10	20	ns
	$t_r$			30	50	ns
Turn-off time	$t_{d(off)}$			30	50	ns
	$t_f$			20	30	ns

Reverse diode

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Avalanche capability	$I_{AV}$	$L = 100\ \mu\text{H}$ , $T_{ch} = 25^\circ\text{C}$ * see Fig1 and Fig2	10.0			A
Diode forward on-voltage	$V_{SD}$	$I_F = 2 \times I_{DR}$ $V_{GS} = 0\text{ V}$ , $T_{ch} = 25^\circ\text{C}$		1.15	1.8	V
Reverse recovery time	$t_{rr}$	$I_F = I_{DR}$ $V_{GS} = 0\text{ V}$ $-di_F/dt = 100\text{ A}/\mu\text{s}$ $T_{ch} = 25^\circ\text{C}$		130		ns
Reverse recovery charge	$Q_{rr}$				750	

7. Thermal resistance

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance	$R_{th_{ch-c}}$				4.17	$^\circ\text{C}/\text{W}$
	$R_{th_{ch-a}}$				62.5	$^\circ\text{C}/\text{W}$

Fig.1 Test circuit

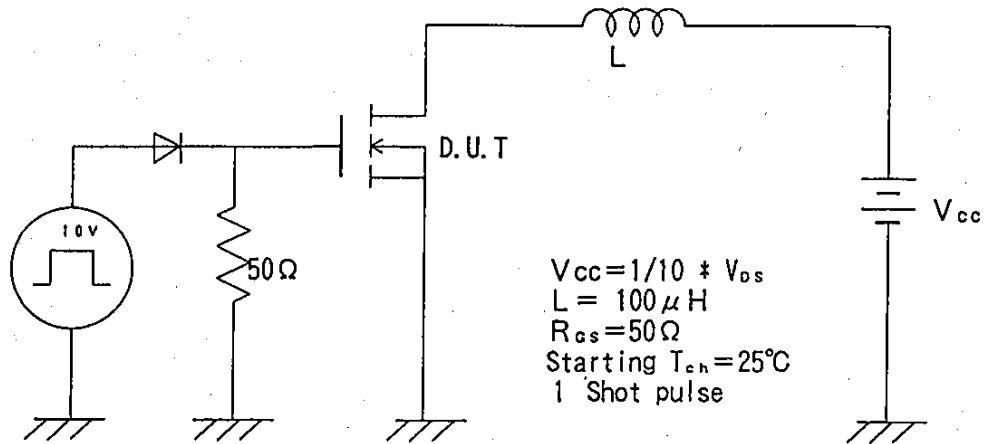
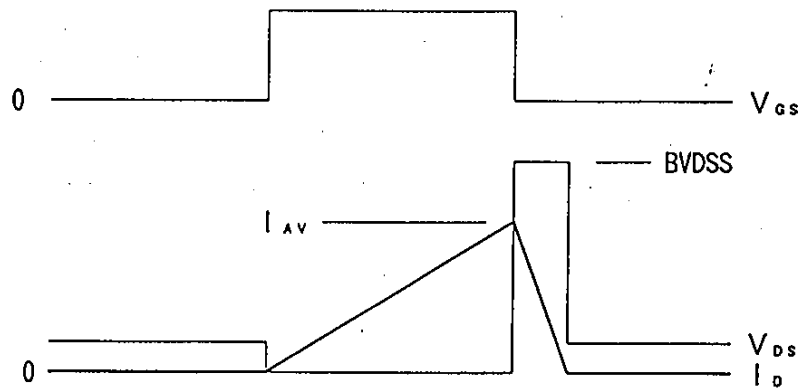
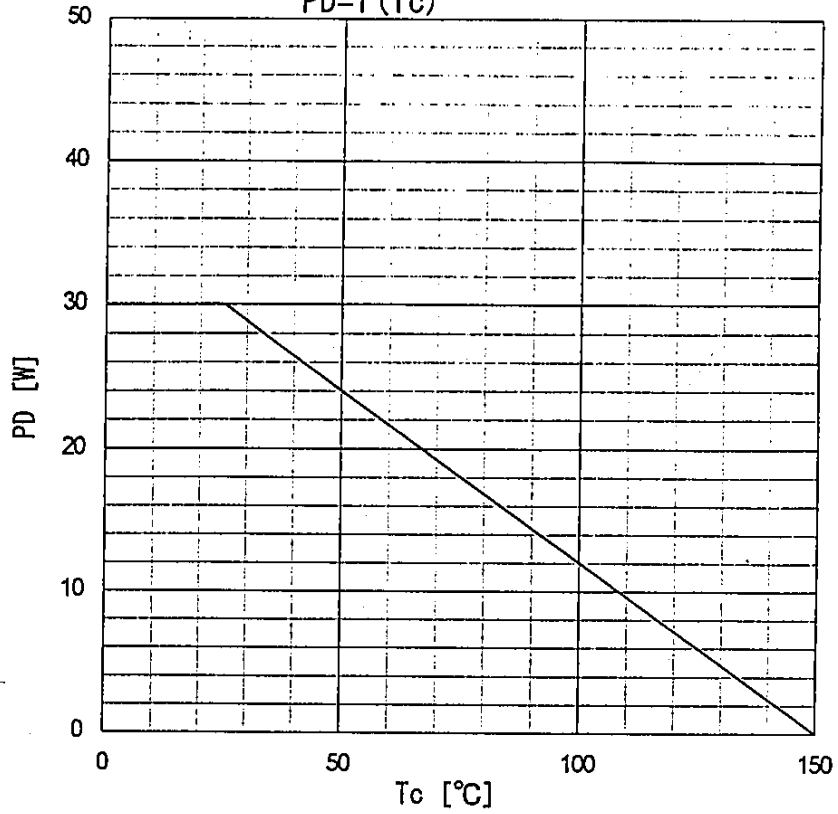


Fig.2 Operating waveforms

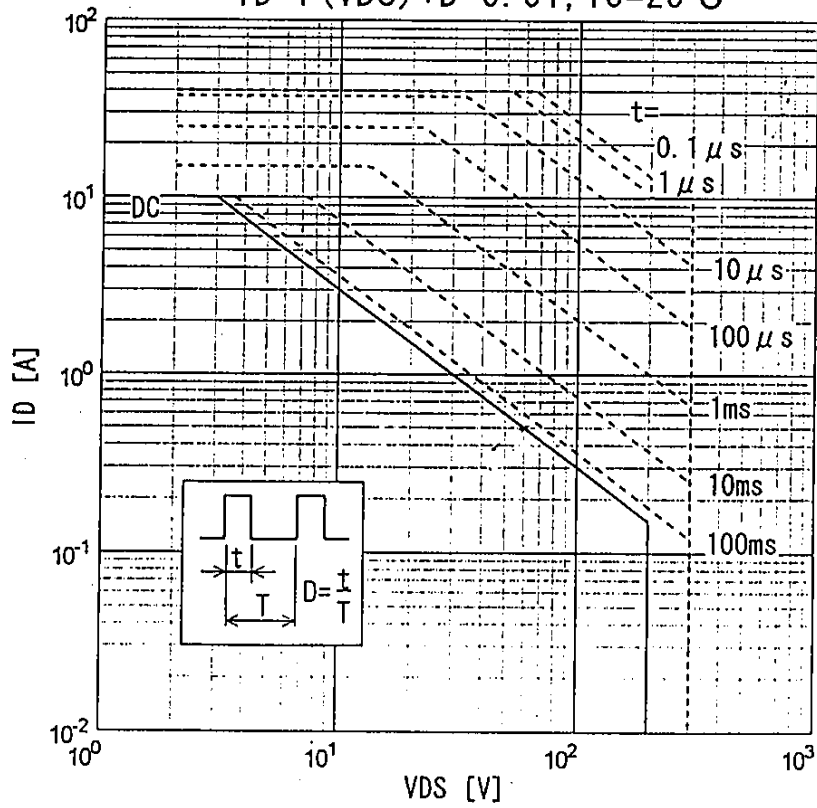




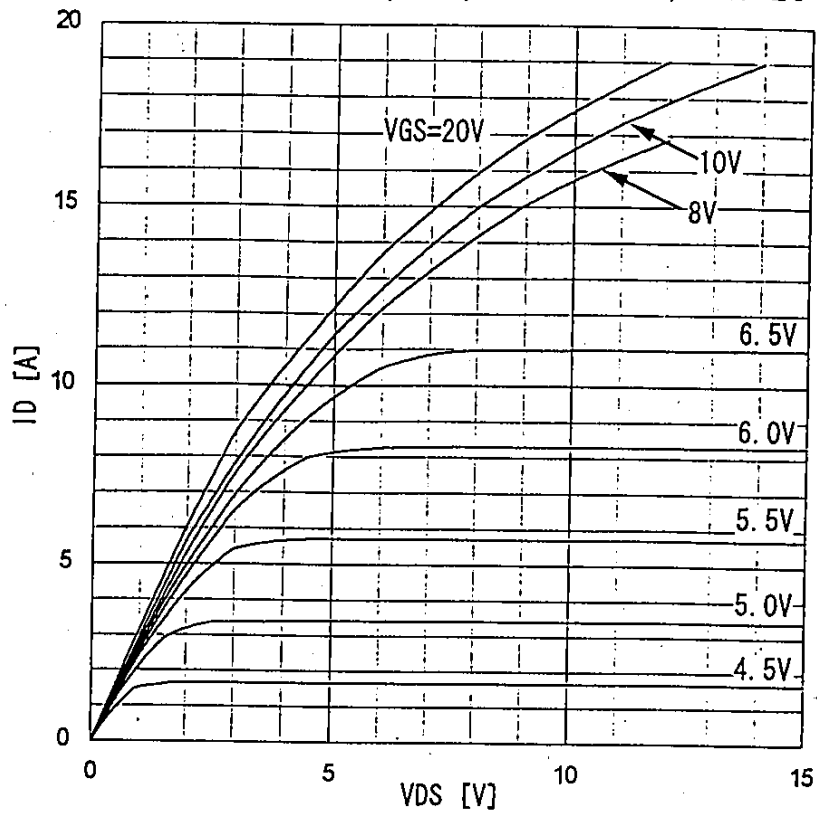
Power Dissipation  
 $PD=f(T_c)$



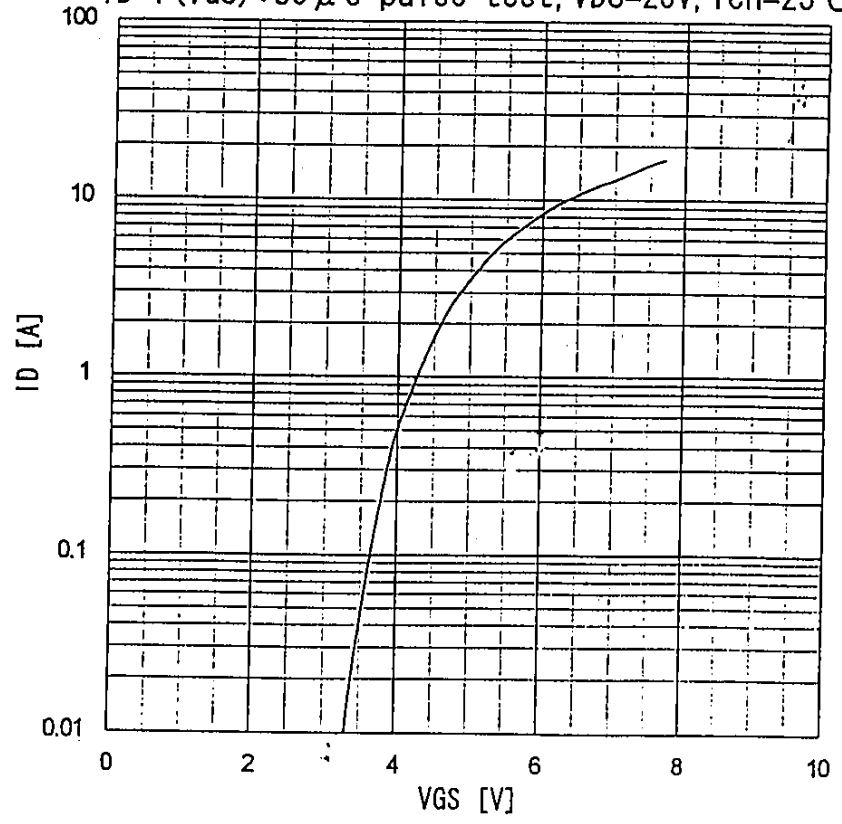
Safe operating area  
 $ID=f(V_{DS}) : D=0.01, T_c=25^\circ C$



Typical output characteristics  
 $I_D = f(V_{DS}) : 80 \mu s$  pulse test,  $T_{ch} = 25^\circ C$

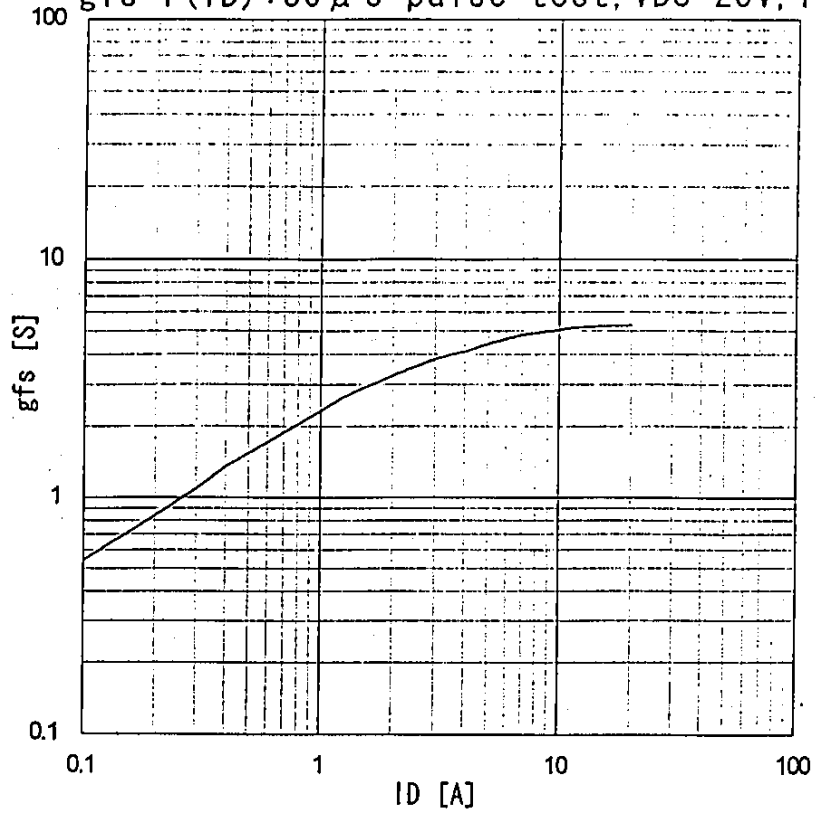


Typical transfer characteristic  
 $I_D = f(V_{GS}) : 80 \mu s$  pulse test,  $V_{DS} = 25V$ ,  $T_{ch} = 25^\circ C$



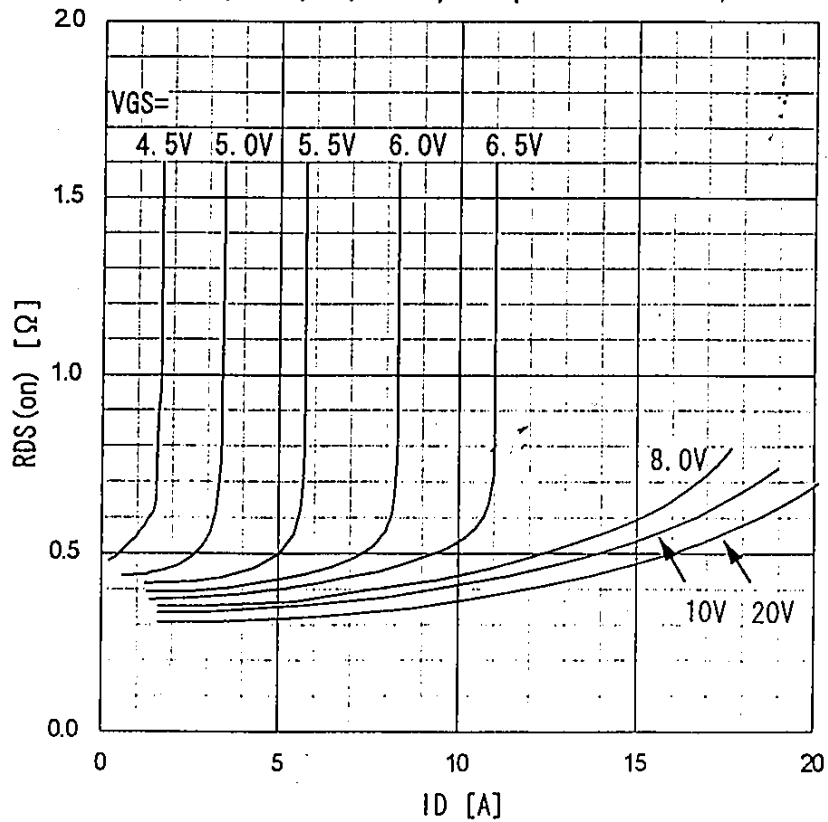
Typical transconductance

$g_{fs} = f(I_D)$ : 80  $\mu$ s pulse test,  $V_{DS} = 25V$ ,  $T_{ch} = 25^\circ C$



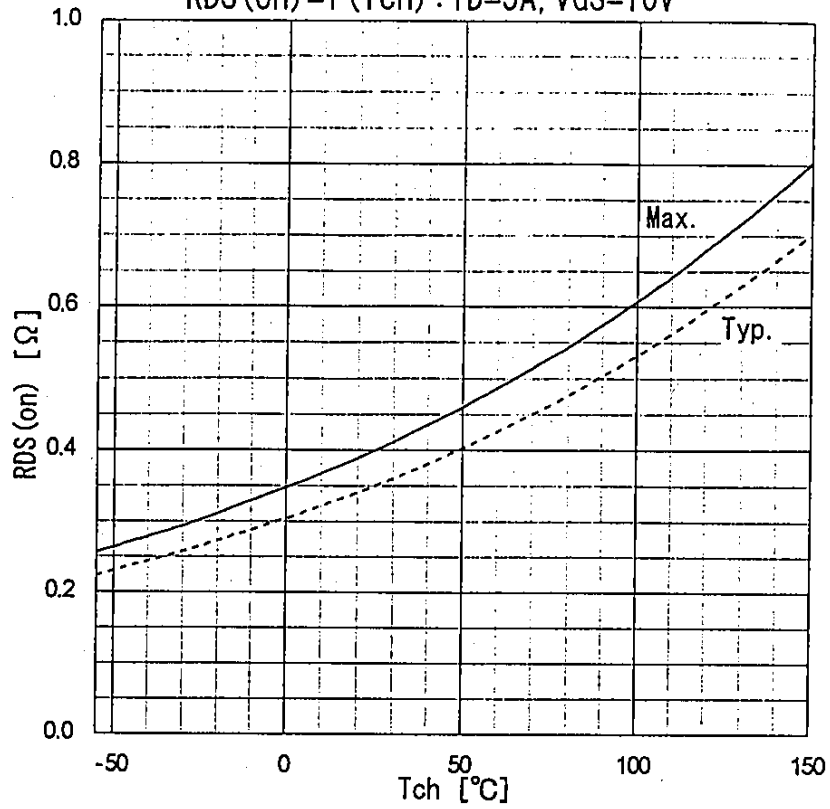
Typical drain-source on-state resistance

$R_{DS(on)} = f(I_D)$ : 80  $\mu$ s pulse test,  $T_{ch} = 25^\circ C$

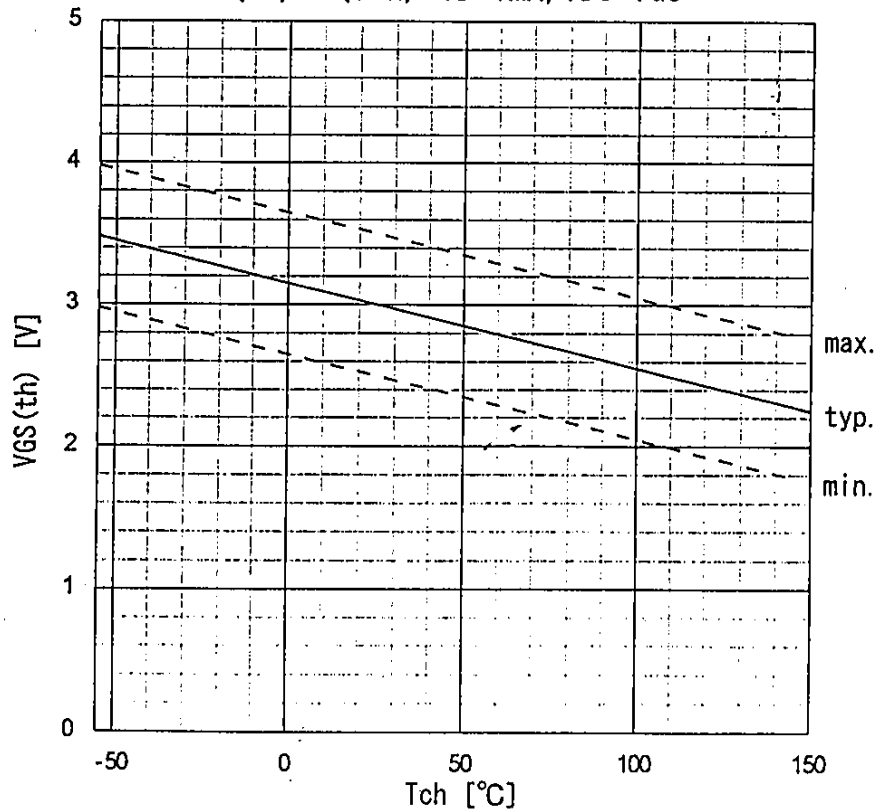




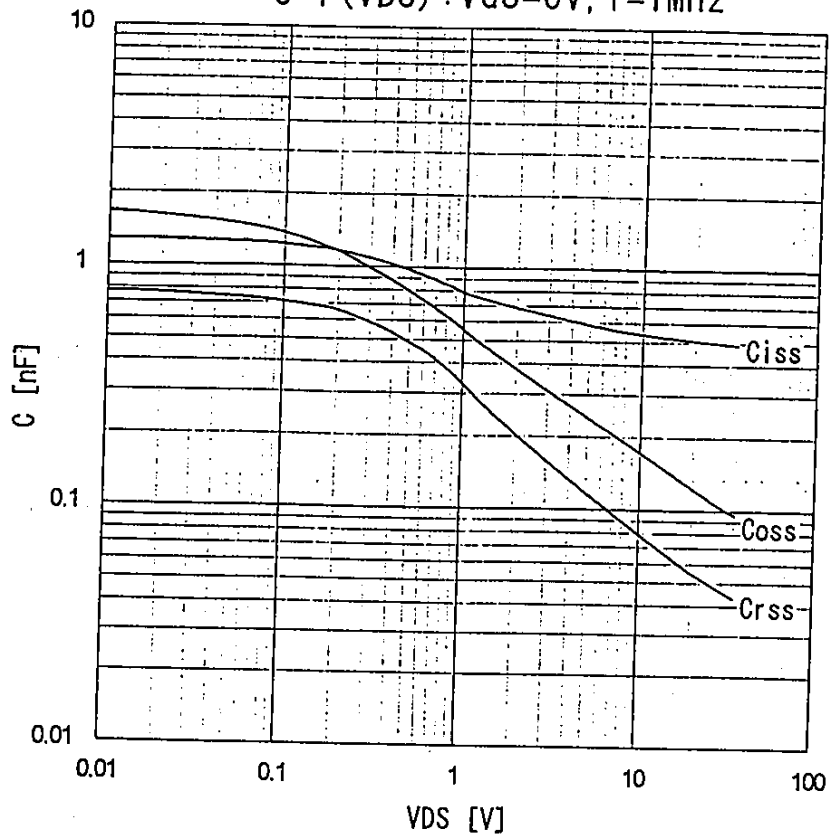
Drain-source on-state resistance  
 $R_{DS(on)} = f(T_{ch}) : I_D = 5A, V_{GS} = 10V$



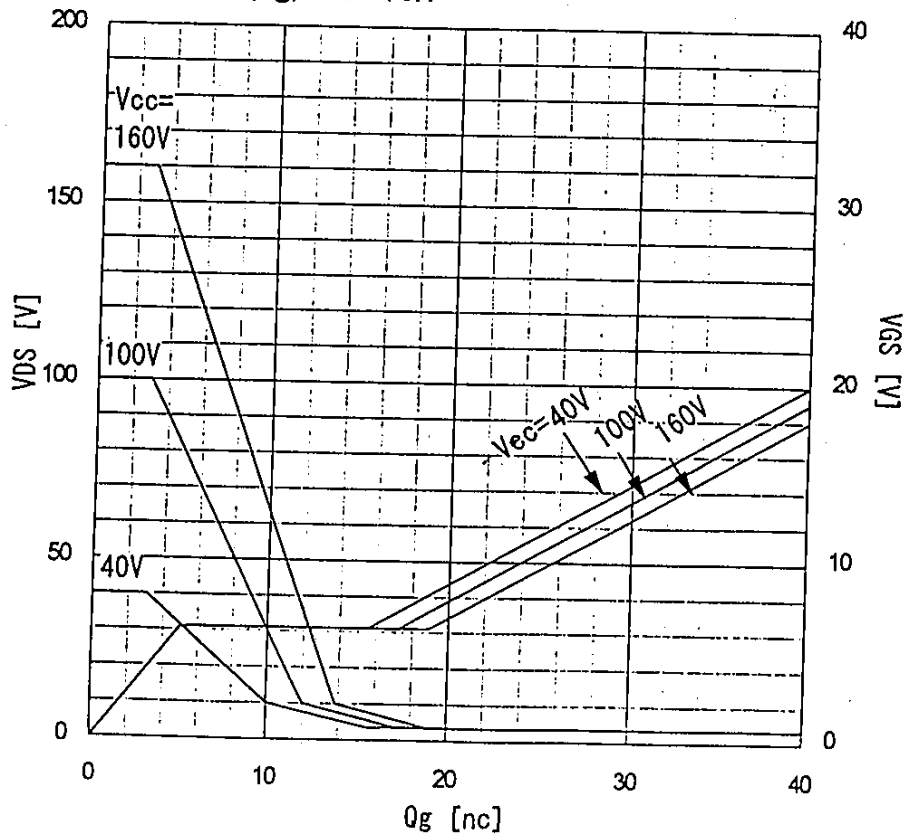
Gate threshold voltage  
 $V_{GS(th)} = f(T_{ch}) : I_D = 1mA, V_{DS} = V_{GS}$



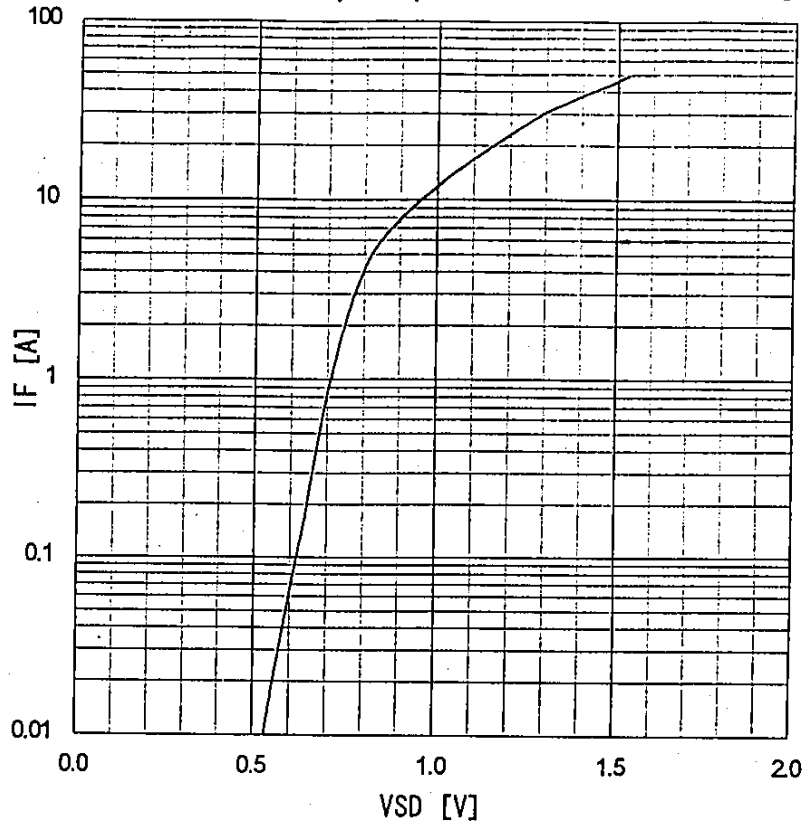
Typical Capacitances  
 $C=f(V_{DS}) : V_{GS}=0V, f=1MHz$



Typical gate charge characteristics  
 $V_{GS}=f(Q_g) : I_D=10A$



Forward characteristic of reverse diode  
 $I_F = f(V_{SD}) : 80 \mu s$  pulse test  $T_{ch} = 25^\circ C$   $V_{GS} = 0V$



Transient thermal impedance  
 $Z_{th}(ch-c) = f(t)$  parameter:  $D = t/T$

